502687007 02/19/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2733612

SUBMISSION TYPE:			NEW ASSIGNMENT			
NATURE OF CONVEYANCE:			ASSIGNMENT			
CONVEYING PARTY	'DATA	•				
		N	lame	Execution Date		
YOSHINORI MATSUI				02/17/2014		
RECEIVING PARTY	DATA					
Name: MICRON TECHNOLOG			OGY, INC.			
Street Address:	8000 SOUTH	8000 SOUTH FEDERAL WAY				
City:	BOISE					
State/Country:	IDAHO					
Postal Code:	83716-9632					
Application Number: 141845						
Application Number: 14184566						
Application Number:		141845	566			
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CORRESPONDENCE Fax Number: Phone: Email: Correspondence will Correspondent Name Address Line 1: Address Line 2:	E DATA (206- ip.do be sent via US Ma e: DOF COL 701 SEA	3)299-92 -903-880 	88 00 @dorsey.com <i>the email attempt is unsuccessful.</i> WHITNEY LLP-IP DEPTMTI CENTER ENUE, SUITE 6100			
CORRESPONDENCE Fax Number: Phone: Email: Correspondence will Correspondent Name Address Line 1: Address Line 2: Address Line 4:	E DATA (206- 206- ip.do be sent via US Ma E: DOF COL 701 SEA	3)299-92 -903-880 	88 O0 @dorsey.com the email attempt is unsuccessful. WHITNEY LLP-IP DEPTMTI CENTER ENUE, SUITE 6100 WASHINGTON 98104-7043			
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PATENT REEL: 032249 FRAME: 0312

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Yoshinori Matsui Filed: Concurrently herewith For: SEMICONDUCTOR DEVICE	Docket No. P243862.US.01 Disclosure No. ELPA-0080.00/US				
ASSIGNMENT:					
_X Enclosed for recording Previously recorded Date: Reel:					

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83716-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the JP patent application which was filed on February 22, 2013, and assigned Application No. 2013-033131 and is entitled "SEMICONDUCTOR DEVICE"; such application and any legal equivalent thereof in a foreign country, including the right to claim priority and, in and to, all Letters Patent to be obtained for said invention by the above application or any and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America:

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

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WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Signature: YOSHINORI MATSUI YOSHINORI MATSUI	Date: 2014/2/17
Witness # 1: Signature: Shoji EGUCHI	Date: <u>Feb.</u> 17, 2014
Witness # 2: Signature: Witness Name: Yasuhiro YAMAYA	Date: 2/11/2019